



SCWL252010XXXXQ Series

Features

- This specification applies Low Profile Power Inductors
- u Halogen free, Lead Free, RoHS Compliance

Applications

SCWL252010XXXXQ series is generic applied in portable DC

to DC converter line.

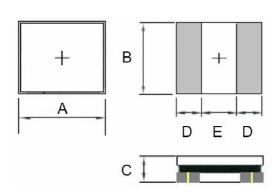
- **u** Mobile phones
- u HDDs
- u DSCs
- **u** PADs
- u LCD, LED display, etc.

Part Numbering

SCWL	2520	10	2R2	M	Т	F	Q
(1)	(2)	(3)	(1)				
(1)	(2)	(3)	(4)	(3)	(0)	(1)	(0)

- 1 Product Series
- 2 Size Code: the first two digitals: length(mm), the last two digitals: width(mm)
- 3 Thickness (mm)
- 4 Inductance (μH), eg. 2R2=2.2μH; R47=0.47μH
- 5 Inductance tolerance, M: ±20%; Y: ±30%
- 6 Packaging: T Embossed plastic tape, 7" reel.
- 7 Soldering: Green Parts, F Lead-Free for whole chip
- 8 Model Code

Construction & Dimensions



Symbol	252010		
Α	2.5 -0.1/+0.2		
В	2.0 -0.5/+0.35		
С	1.02 Max		
D	0.85 REF		
E	0.80 REF		





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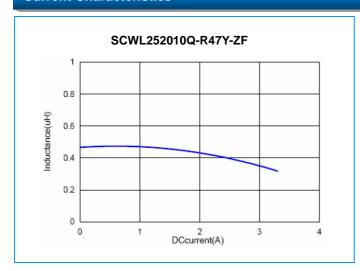
Electrical Characteristics

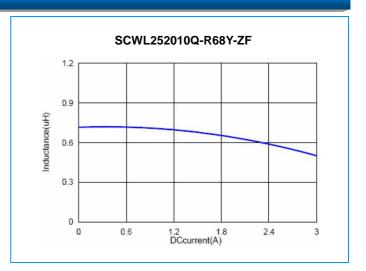
Part Number	Inductance	Tolerance	Test Frequency (Hz)	DCR (Ω) ±20%	I sat (A)		I rms (A)	
Part Number	(μH)	(%)			Тур.	Max.	Тур.	Max.
SCWL252010R47YTFQ	0.47	±30%	0.1V / 1M	0.030	2.85	2.57	2.80	2.50
SCWL252010R68YTFQ	0.68	±30%	0.1V / 1M	0.039	2.70	2.45	2.45	2.20
SCWL2520101R0YTFQ	1.0	±30%	0.1V / 1M	0.055	2.45	2.05	2.20	1.80
SCWL2520101R5YTFQ	1.5	±30%	0.1V / 1M	0.090	1.80	1.70	1.70	1.55
SCWL2520102R2MTFQ	2.2	±20%	0.1V / 1M	0.125	1.60	1.55	1.55	1.40
SCWL2520104R7MTFQ	4.7	±20%	0.1V / 1M	0.250	1.10	0.95	1.05	0.92

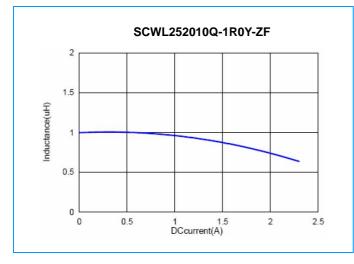
Note:

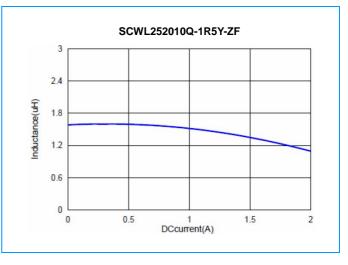
- 1. Isat: Based on inductance change (\triangle L/L0: \le -30%) @ ambient temp. 25°C
- 2. Irms: Based on temperature rise (△T: 40°C typ.)

Current Characteristics







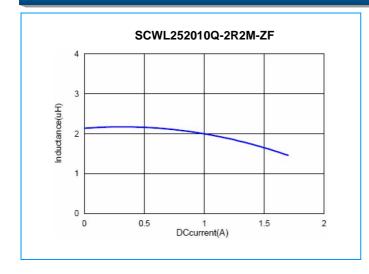


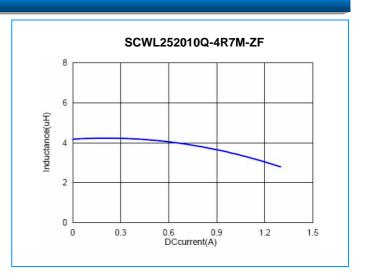




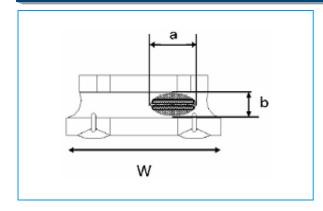
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Current Characteristics





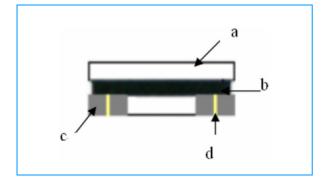
Appearance



Exposed wire tolerance limit of coating resin part on product side. Size of exposed wire occurring to coating resin is specified below.

- Width direction (dimension a): Acceptable when a≤w/2
 Nonconforming when a>w/2
- 2. Length direction (dimension b): Dimension b is not specified.
- The total area of exposed wire occurring to each sides is not greater than 50% of coating resin area, and is acceptable.

Material Lists



No.	Item	Material
а	Core	Ferrite Core
b	Coating	Epoxy with magnetic powder
С	Termination	Tin (Pb-Free)
d	Wire	Enameled Copper Wire





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Soldering and Mounting

Soldering

Mildly activated rosin fluxes are preferred. SOCAY terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

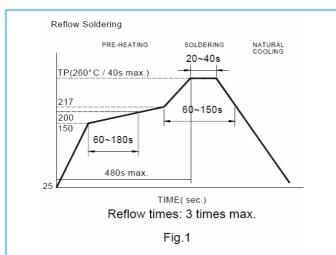
Solder re-flow

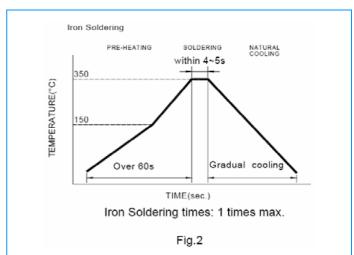
Recommended temperature profiles for re-flow soldering in Figure 1.

Solder Iron (Figure 2):

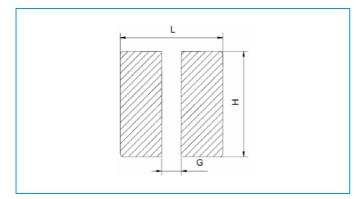
Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

- Never contact the ceramic with the iron tip Use a 20 watt soldering iron with tip diam eter of 1.0mm u u u
 - 355 ℃ tip temperature (max) u 1.0mm tip diameter (max) u Limit soldering time to 4~5 sec.





Recommended PCB Board Pattern



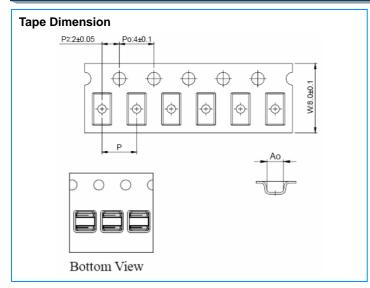
L (mm)	G (mm)	H (mm)
2.9	0.8	2.4



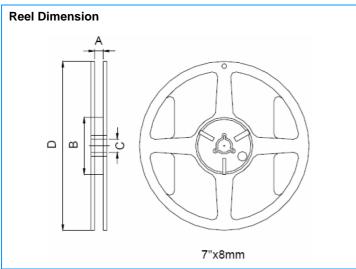


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Packaging Information

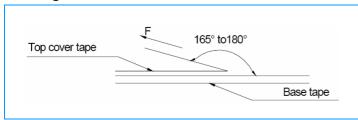


Symbol	252010	
A0 (mm)	2.85±0.1	
B0 (mm)	2.45±0.1	
K0 (mm)	1.40±0.1	
P (mm)	4.00±0.1	
t (mm)	0.23±0.05	



Symbol	7" ×8 mm
A (mm)	8.4±1.0
B (mm)	50 min
C (mm)	13±0.8
D (mm)	178±2

Tearing off force



The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions.

Room Temp.	Room Humidity	Room atm	Tearing Speed
(°C)	(%)	(hPa)	mm/min
5~35	45~85	860~1060	300

Packaging Quantity

Туре	PCS / Reel
SCWL252010XXXXQ	2,000





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Reliability and Test Condition

Test Item	Performance	Test Method and Remarks				
Operating Temperature	-55 ~ +125°C (For products in unopened tape package, less than 40 °C)					
Electrical Performance	Electrical Performance Test					
Inductance L Q SRF DC Resistance	Refer to standard electrical characteristic list	Agilent-4291, Agilent-4287 Agilent-4192, Agilent-4285 Agilent-4192 Agilent-4338				
Rated Current	Base on temp. rise & △L/L0A ≤30%	Saturation DC Current (Isat) will cause L0 to drop approximately \triangle L(%)				
Mechanical Performance	e Test	approximately \(\triangle \triangle (70)				
Appearance: No damage Temperature Inductance: within±10% of initial value		Temperature (°C) Time (s) Temperature ramp/immersion and emersion rate				
Solder Heat Resistance	Q: Shall not exceed the specification value RDC: within ±15% of initial value and shall not	260±5 (Solder Temp) 10±1 25mm/s±6mm/s 1				
	exceed the specification value	Depth: completely cover the termination				
Solderability Test	More than 95% of terminal electrode should be covered with solder	Preheating Dipping Natural cooling 235°C 150°C 60 60 second 4±1 second After fluxing, component shall be dipped in a melted solder bath at 235±25°C for 4±1seconds				
Reliability Test						
Life Test	Appearance: No damage Inductance: within±10% of initial value Q: shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times. IPC/JEDEC J-STD-020D Classification Reflow Profiles Temperature: 125±2°C(Bead) Temperature: 85±2°C(Inductor) Applied current: rated current Duration: 1000±12hrs Measured at room temperature after placing for 24±2 hrs				
Thermal shock		Preconditioning: Run through IR reflow for 2 times. IPC/JEDEC J-STD-020D Classification Reflow Profiles Step1: -40±2°C 30±5min Step2: 25±2°C ≤0.5min Step3: 105±2°C 30±5min Number of cycles: 500 Measured at room temperature after placing for 24±2 hrs				
Humidity Resistance Test		Preconditioning: Run through IR reflow for 2 times IPC/JEDEC J-STD-020D Classification Reflow Profiles Humidity: 85±2% R.H, Temperature: 85°C±2°C Duration: 1000hrs Min. with 100% rated current Measured at room temperature after placing for 24±2 hrs				
Vibration Test		Preconditioning: Run through IR reflow for 2 times. IPC/JEDEC J-STD-020D Classification Reflow Profiles Oscillation Frequency: 10~2K~10Hz for 20 minutes Equipment: Vibration checker Total Amplitude: 0.15mm±10% Testing Time: 12 hours(20 minutes, 12 cycles each of 3 orientations)				